



# The NanoFab

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*NanoFab Manager*



# NanoFab Overview

Providing researchers world-wide customized processing tools for nanoscale fabrication and measurement on a shared-use, cost-reimbursable basis through a straightforward application process designed to get users into the facility in a few weeks.

- NanoFab Staff: 12

  - Process Engineers: 7

  - Process Technicians: 1

  - Administrative Support: 2

  - Equipment Technicians: 2

- 19,000 ft<sup>2</sup> cleanroom; 8,000 ft<sup>2</sup> at class 100

- Advanced Nanofabrication and Metrology tools

- Additional shared-use tools outside the cleanroom

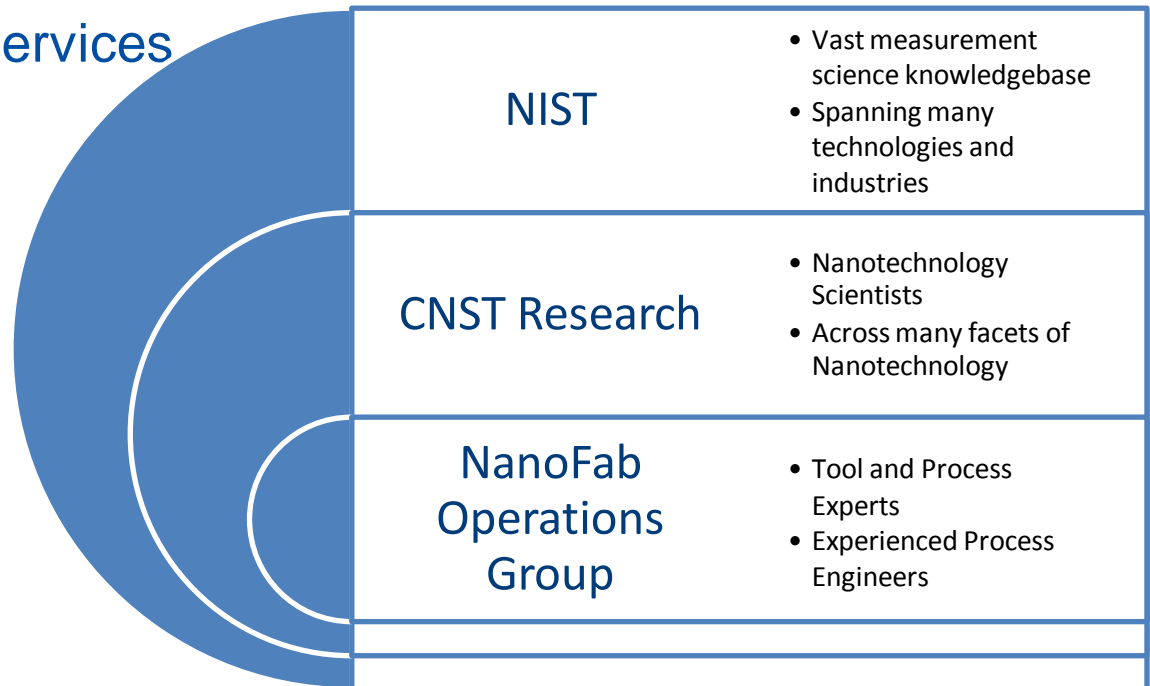
# Outline

- Expertise
- Environment
- Tools
- Processes
- Accessibility
- Continuous Improvement
- Outreach



# NanoFabrication Expertise

- Provide One-On-One Expert Training on Tools
- Ongoing Process Development Consulting to all users
  - Over 170 Years of Process Development Experience on Staff
- Process Development Services
  - Fee Based
- Vast Technical Resources to draw on as needed



# The NanoFab Environment

- 19,000 ft Cleanroom; 8,000 ft<sup>2</sup> at class 100
  - Raised Floor Vertical Laminar Airflow
- Tight temperature control facilitates advanced processes and tools
  - 0.25°F Temperature Control
  - 2.0% Relative Humidity Control
- State-of-the-art Deionized Water Generation Plant
- Compatible with Substrate Sizes up to 150 mm dia.
- Automatic Hazardous Gas Monitoring
  - Direct connection to NIST firehouse
- Multi-Camera CCTV Monitoring
- Coral Software Used for Account Tracking



# NanoFab Tools

- Thin Films
  - Sputter Deposition
    - 1 sputter tool dedicated to magnetic materials
  - E-beam Evaporation
  - Thermal Evaporation
  - LPCVD
  - PECVD
    - Including bio-compatible Parylene
  - Spin-On-Glass
  - Oxidation



# NanoFab Tools

- Reactive Ion Etching
  - ICP, chlorine based metal etcher
  - Deep-RIE for high aspect ratio etching
    - An invaluable tool for MEMS research
  - 2ea Fluorine Based Multipurpose systems
    - Supports research of new RIE processes
  - XeF<sub>2</sub> for rapid isotropic silicon etching
  - Microwave Oxygen Asher

*more RIE to come*



# NanoFab Tools

- Lithography
  - Vistec VB300 E-Beam Lithography
  - MA6 Front/Backside Contact Aligner
  - MA8 Frontside Contact Aligner
  - Nano-imprint Lithography
  - Laser Pattern Generator



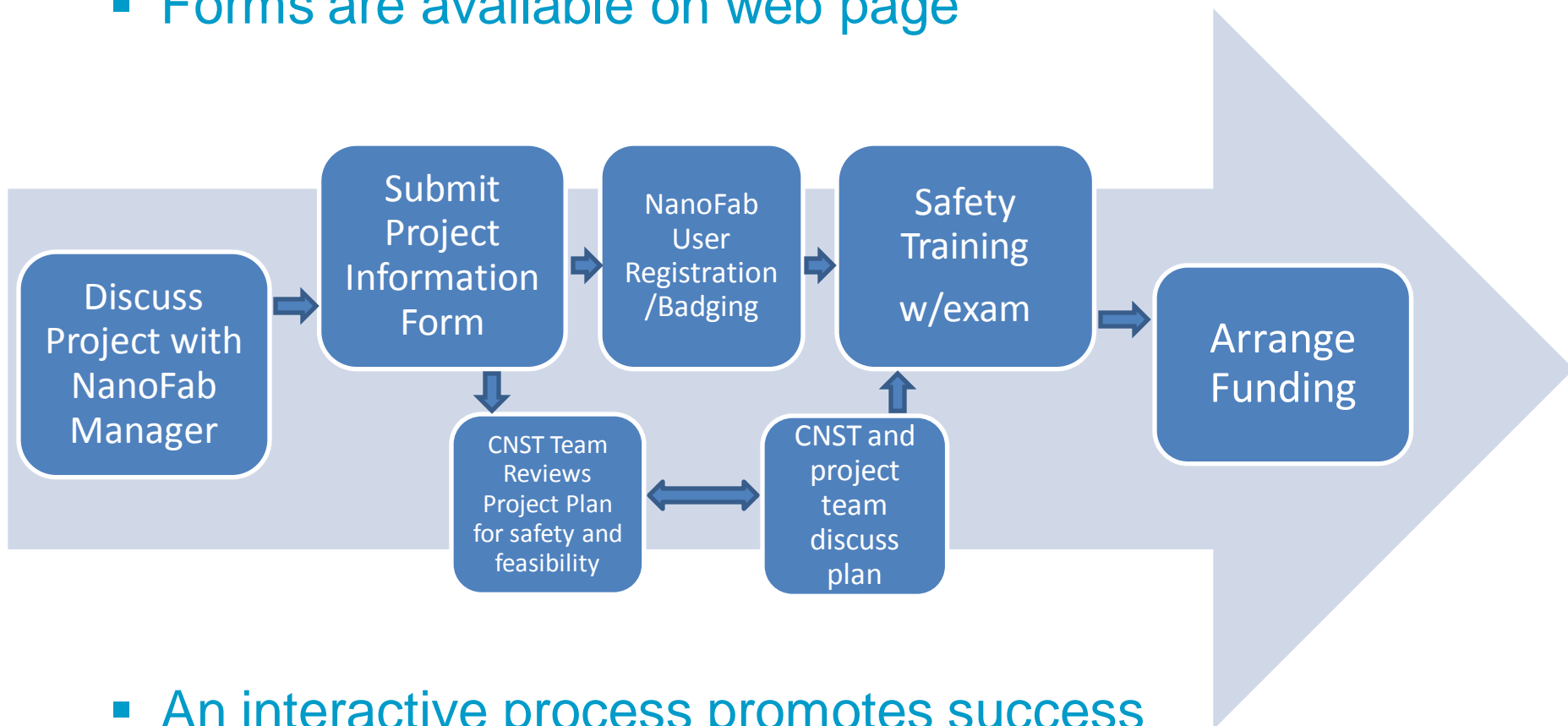


# NanoFab Tools

- Metrology
  - Stress Measurement Tool: Toho Technology FLX-2320
  - Table-top SEM: Hitachi TM-1000
  - Scanning Electron Microscope: Zeiss Ultra-60 FESEM
  - Atomic Force Microscope: Veeco Dimension 3100
  - Atomic Force Microscope: Digital Instruments/Veeco
  - Dimension 3000 Contact Angle Goniometer
  - Spectroscopic Ellipsometer: Woollam XLS-100
  - Nanospec Reflectometer
  - Nanometrics Contact Profilometer: Dektak 6M

# Accessibility

- The Registration Process is Straight Forward
  - Forms are available on web page



- An interactive process promotes success

# NanoFab Process Development

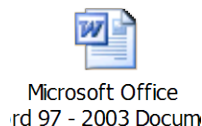


Building Blocks for Nanotechnology Development

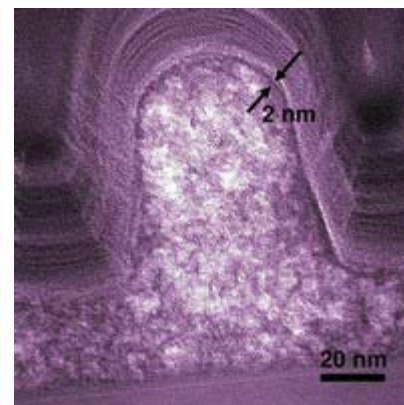
E-beam Lithography Process EBL001	E-beam Lithography Process EBL002	E-beam Lithography Process EBL003	E-beam Lithography Process EBL004
Photolith Process CPL001	Photolith Process CPL002	Photolith Process CPL003	Photolith Process CPL004
Metal Dep Recipe SPT001	Metal Dep Recipe SPT002	Metal Dep Recipe SPT003	Metal Dep Recipe SPT004

# Established Processes Facilitate Success

E-beam Lithography Process EBL001	E-beam Lithography Process EBL002	E-beam Lithography Process EBL003	E-beam Lithography Process EBL004
Photolith Process CPL001	Photolith Process CPL002	Photolith Process CPL003	Photolith Process CPL004
Metal Dep Recipe SPT001	Metal Dep Recipe SPT002	Metal Dep Recipe SPT003	Metal Dep Recipe SPT004

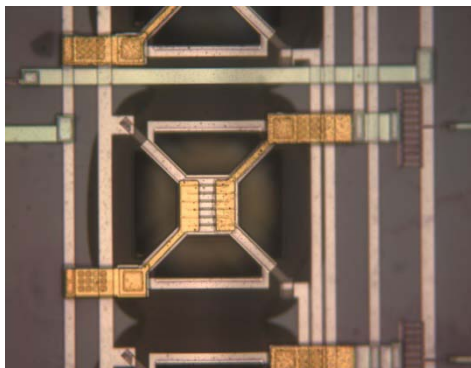


Hyun Wook Ro NIST/



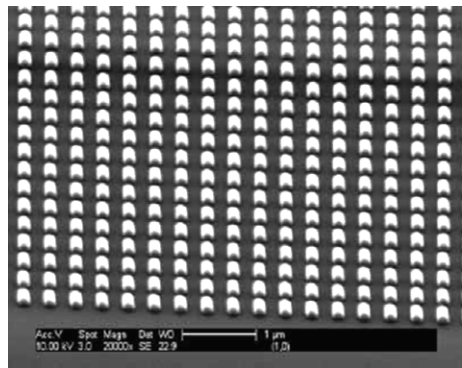
Nano-Imprint Technology

Dr. Yaqub Afridi NIST/SED



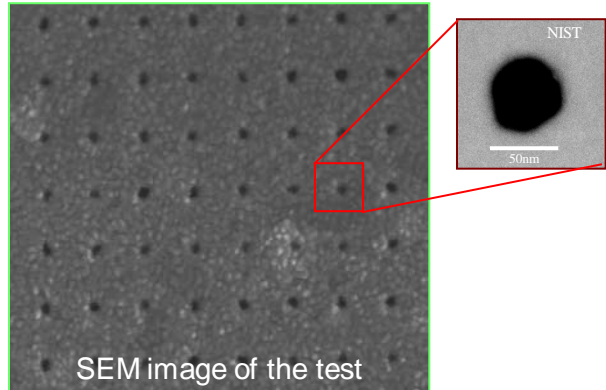
Micro-scale Gas Sensor

Prof. Sungho Jin UCSD



Magnetic Nanostructures

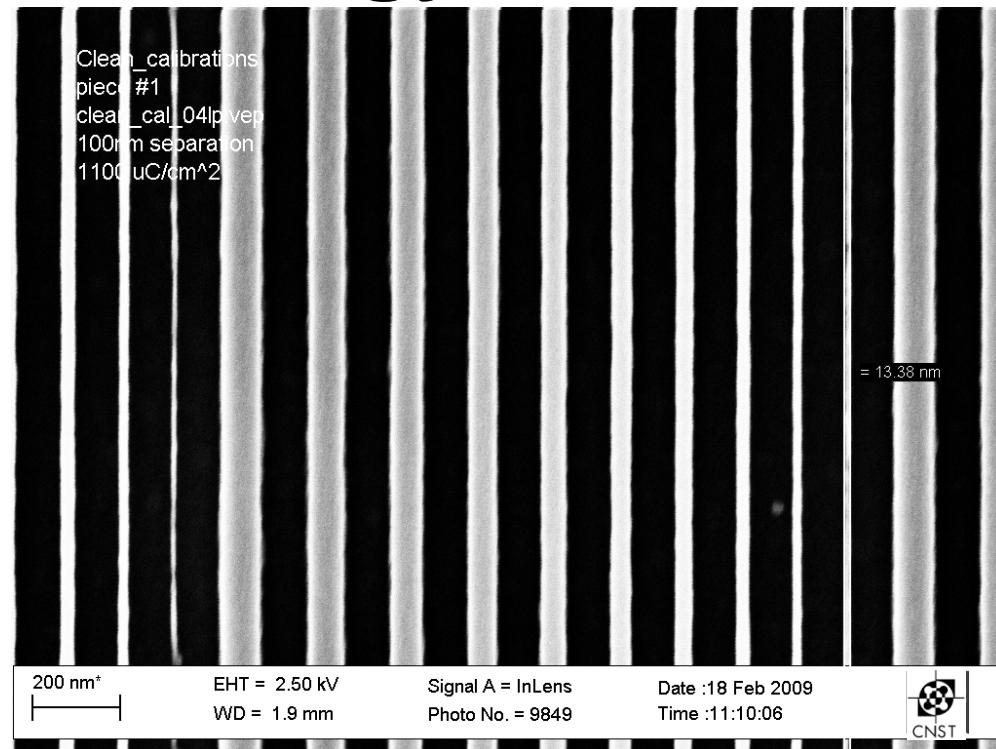
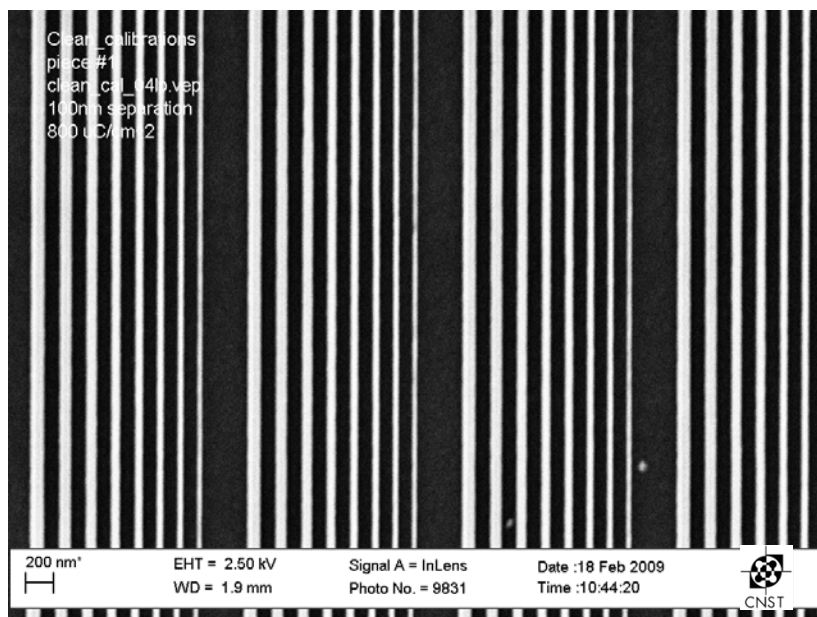
Dr. Wenyong Wang NIST/SED



Nanopore Device for Molecular Transport Measurement

# Setting New Standards in Nanotechnology

- **NIST/SEMATECH**  
 Project to create AFM  
 Standards



- **Patterned HSQ Resist on Silicon**

# Continuous Improvement

## ■ New Capabilities

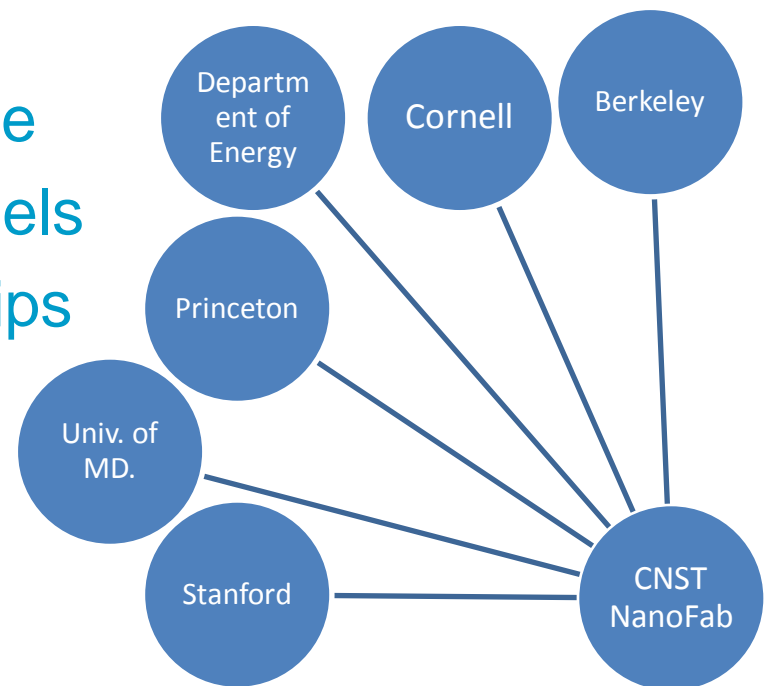
- JEOL JBX 6300FS E-Beam writer 4/2009
  - Provides needed capacity of E-Beam Lithography
  - Back up for this vital capability
- Oxford Atomic Layer Deposition System 4/2009
- 2 more Oxford Multipurpose RIE Systems 4/2009
  - Both are ICP systems with 12 gas input channels
  - Cryo and heated substrate capability
- Nanometrics 6100 Reflectometer 3Q2009

## ■ Improved Systems

- New Web based Project Registration 3Q2009
- Coral Based Tool Interlocks 4/2009

# Ready for Prime Time

- The Time is right to launch Operation Outreach
  - The Tool set in the NanoFab is nearing Completion
  - The clean room environment has stabilized
  - Staffing is complete
  - Baseline Processes are in place
  - We have studied our Role Models
  - Established working relationships



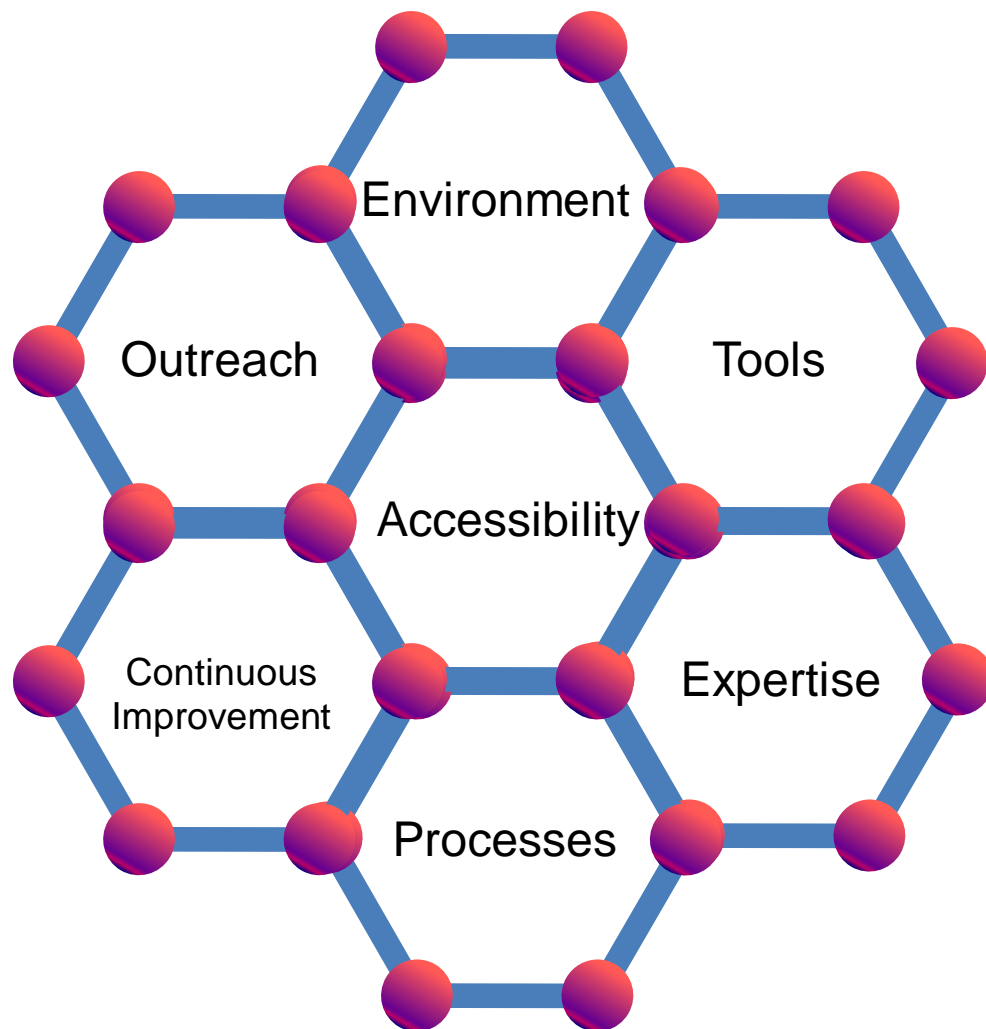
# NanoFab Operation Outreach

## Making Our Presence Known is Key to our Success

- Increased Presence at Conferences/Trade Shows
- 2 Open houses planned for Q3 and Q4
- Nanofabrication Workshop in Q3
- Working with Local Tech Councils and Users Groups
- Aggressive outreach within NIST
- New Database being developed to track and maintain growth



# NanoFab Summary



## Helping the US Make Measured Progress in Nanotechnology

